

RF Power MOSFET Transistor

5W, 2-175MHz, 28V

M/A-COM Products
Released; RoHS Compliant

Features

- N-Channel enhancement mode device
- DMOS structure
- Lower capacitances for broadband operation
- High saturated output power
- Lower noise figure than bipolar devices

ABSOLUTE MAXIMUM RATINGS AT 25° C

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	65	V
Gate-Source Voltage	V_{GS}	20	V
Drain-Source Current	I_{DS}	1.4	A
Power Dissipation	P_D	15.8	W
Junction Temperature	T_J	200	°C
Storage Temperature	T_{STG}	-55 to +150	°C
Thermal Resistance	θ_{JC}	11.1	°C/W

TYPICAL DEVICE IMPEDANCE

F (MHz)	Z_{IN} (Ω)	Z_{LOAD} (Ω)
100	15 - j121.0	57.0 + j23.0
150	39.0 - j77.0	55.0 + j23.0
175	41.0 - j38.0	56.0 + j19.0
200	34.0 - j14.0	56.0 + j20.0
$V_{DD} = 28V, I_{DQ} = 50mA, P_{OUT} = 5W$		

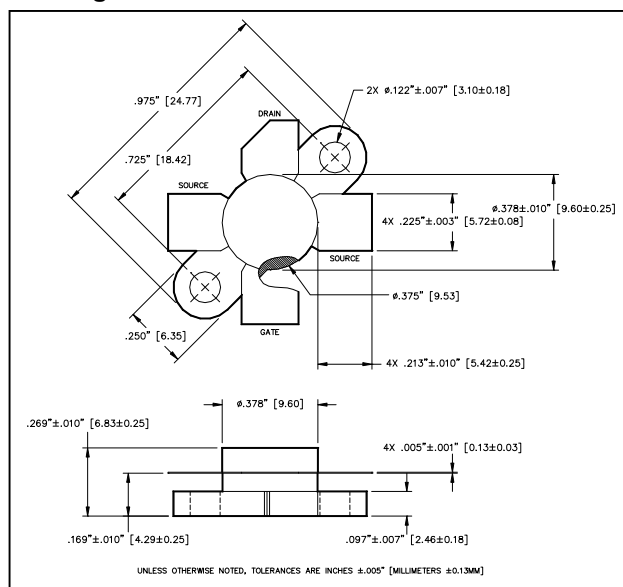
Z_{IN} is the series equivalent input impedance of the device from gate to source.

Z_{LOAD} is the optimum series equivalent load impedance as measured from drain to ground.

ELECTRICAL CHARACTERISTICS AT 25°C

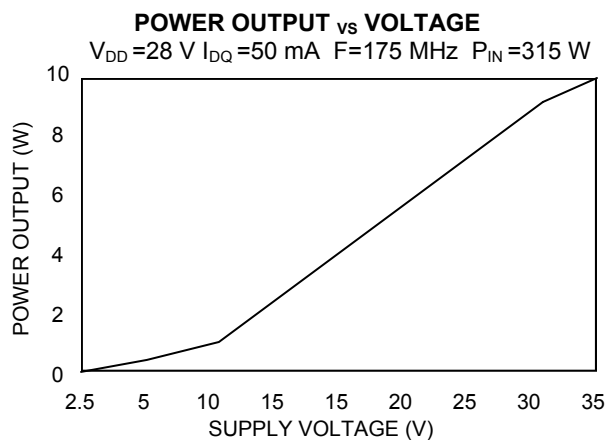
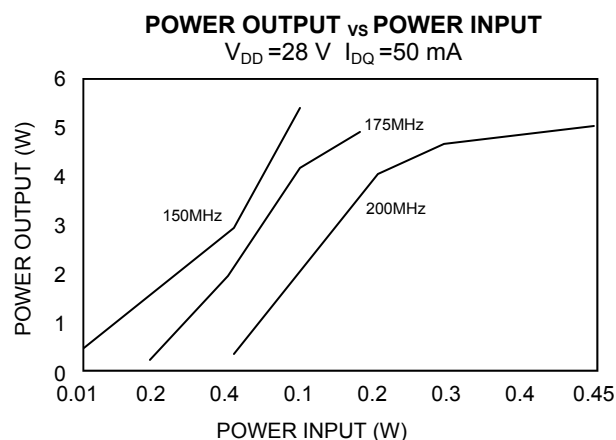
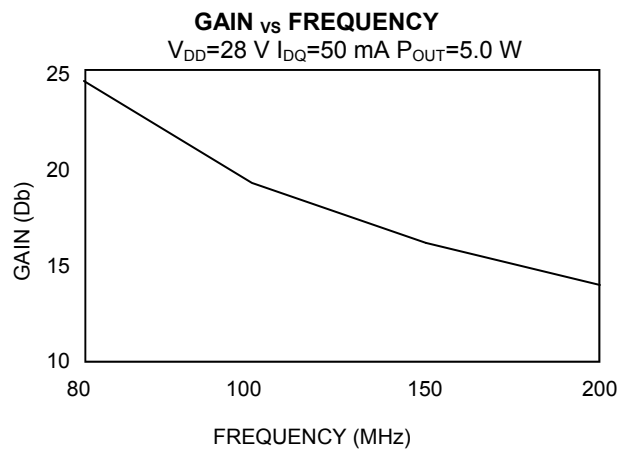
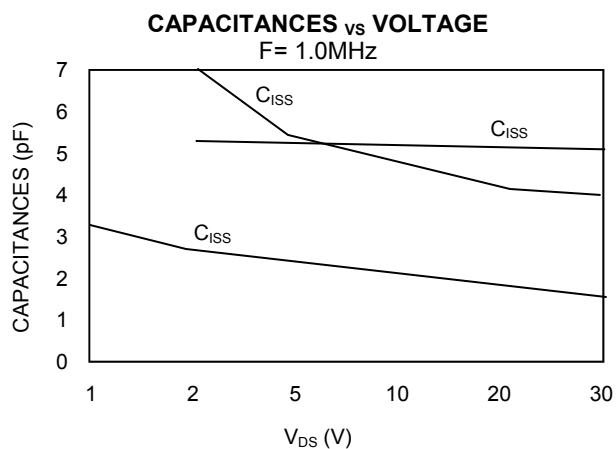
Parameter	Symbol	Min	Max	Units	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	65	-	V	$V_{GS} = 0.0 V, I_{DS} = 20.0 mA$
Drain-Source Leakage Current	I_{DSS}	-	1.0	mA	$V_{GS} = 28.0 V, V_{DS} = 0.0 V$
Gate-Source Leakage Current	I_{GSS}	-	1.0	μA	$V_{GS} = 20.0 V, V_{DS} = 0.0 V$
Gate Threshold Voltage	$V_{GS(TH)}$	2.0	6.0	V	$V_{DS} = 10.0 V, I_{DS} = 10 mA$
Forward Transconductance	G_M	80	-	S	$V_{DS} = 10.0 V, I_{DS} = 10 mA, \Delta V_{GS} = 1.0 V, 80 \mu s$ Pulse
Input Capacitance	C_{ISS}	-	7	pF	$V_{DS} = 28.0 V, F = 1.0 MHz$
Output Capacitance	C_{OSS}	-	5	pF	$V_{DS} = 28.0 V, F = 1.0 MHz$
Reverse Capacitance	C_{RSS}	-	2.4	pF	$V_{DS} = 28.0 V, F = 1.0 MHz$
Power Gain	G_P	11	-	dB	$V_{DD} = 28.0 V, I_{DQ} = 50 mA, P_{OUT} = 5.0 W F = 175 MHz$
Drain Efficiency	η_D	55	-	%	$V_{DD} = 28.0 V, I_{DQ} = 50 mA, P_{OUT} = 5.0 W F = 175 MHz$
Load Mismatch	VSWR-T	-	20:1	-	$V_{DD} = 28.0 V, I_{DQ} = 50 mA, P_{OUT} = 5.0 W F = 175 MHz$

Package Outline



LETTER DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	24.64	24.89	.970	.980
B	18.29	18.54	.720	.730
C	20.07	20.83	.790	.820
D	9.47	9.73	.373	.383
E	6.22	6.48	.245	.255
F	5.64	5.79	.222	.228
G	2.92	3.30	.115	.130
H	2.29	2.67	.090	.105
J	4.04	4.55	.159	.179
K	6.58	7.39	.259	.291
L	.10	.15	.004	.006

Typical Broadband Performance Curves



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RF INPUT
50 OHM

J1

C1 100pF 350 V.

L1

C2 5pF 350 V.

GROUND
J3

+VBB
J4

C5 1000pF 350 V.

R2 100K OHM 1/2 W.

C4 500pF 350 V.

L2

R1 331 OHM 1/4 W.

Q1 DU2805S

C6 10pF 350 V.

C7 10pF 350 V.

C8 400pF 350 V.

L6

C9 7pF 350 V.

L3

L4

C10 1000pF 350 V.

L5

C11 1000pF 350 V.

C12 25uF 50 V.

+VCC
J5

J2 RF OUTPUT
50 OHM

L1 4 TURNS OF NO. 12 AWG ON ϕ .31"

L2 2 TURNS OF NO. 12 AWG ON ϕ .31"

L3 3 TURNS OF NO. 12 AWG ON ϕ .31"

L4 3 TURNS OF NO. 12 AWG ON ϕ .31"

L5 8 TURNS OF NO. 12 AWG ON ϕ .25"

L6 NO. 12 AWG THROUGH FERRITE BEAD
1" OF NO. 12 AWG

BOARD TYPE FR4 .062" THICK 1 OZ COPPER BOTH SIDES